

# HOPELEX PC-1070S

Polycarbonate resin

#### **General Information**

## Description

- ☐ High viscosity, no mold release agent, no UV stabilizer, no colorant
- □ Compounds

### Applications

Compound raw material

Typical properties <sup>1</sup>				
	Test Method	Typical value	Unit	
Physical				
Melt Flow Index, 300 °C, 1.2kg	ASTM D1238	7	g/10min	
Specific Gravity	ASTM D792	1.20		
Mold Shrinkage	ASTM D955	0.5~0.7	%	
Mechanical				
Tensile Strength, yield, 50mm/min	ASTM D638	630	kgf/cm²	
Tensile Elongation, break, 50mm/min	ASTM D638	>100	%	
Flexural Strength, yield, 10mm/min	ASTM D790	920	kgf/cm <sup>2</sup>	
Flexural Modulus, 10mm/min	ASTM D790	24,000	kgf/cm²	
IZOD Impact Strength, notched, 23 ℃, 1/8"	ASTM D256	85	kg·cm/cm	
notched, 23 ℃, 1/4"	ASTM D256	-	kg·cm/cm	
Thermal				
Heat Distortion Temp. 4.6kgf/cm <sup>2</sup>	ASTM D648	144	°C	
18.6kgf/cm <sup>2</sup>	ASTM D648	133	°C	
Vicat Softening Temp. Rate B/50	ASTM D1525	153	°C	
Optical				
Light Transmittance	ASTM D1003	89	%	
Haze	ASTM D1003	< 0.8	%	
Refractive Index	ASTM D542	1.585		

Notes	ISO 9001, 14001, /TS 16949

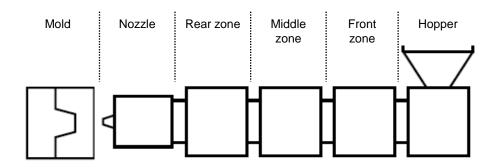
<sup>&</sup>lt;sup>1</sup> Typical properties: these are not to be construed as specifications.



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Processing guides <sup>1</sup>					
		Typical value	Unit		
Drying o	ondition				
Drying te	mperature	120	°C		
Drying tir	ne	4	hr		
Maximun	n moisture content	0.02	%		
Injection	n molding				
Melt temp	perature	290 ~ 310	°C		
Nozzle temperature		280 ~ 300	°C		
	Rear zone	290 ~ 310	°C		
Barrel	Middle zone	280 ~ 300	°C		
	Front zone	270 ~ 290	°C		
Hopper temperature		60 ~ 80	°C		
Mold temperature		60 ~ 90	°C		



## Recycling

Sprues and runners can be reground with virgin resin within the ratio of 20%. Care must be taken to ensure that the regrind is free from impurities and regrind should not be used in applications where impact performance and/or agency compliance are required.

#### **Notes**

ISO 9001, 14001, /TS 16949

<sup>&</sup>lt;sup>1</sup> Processing guides: Typical processing parameters are noted. Actual processing conditions will depend on machine size, mold design, material residence time, shot size, etc.